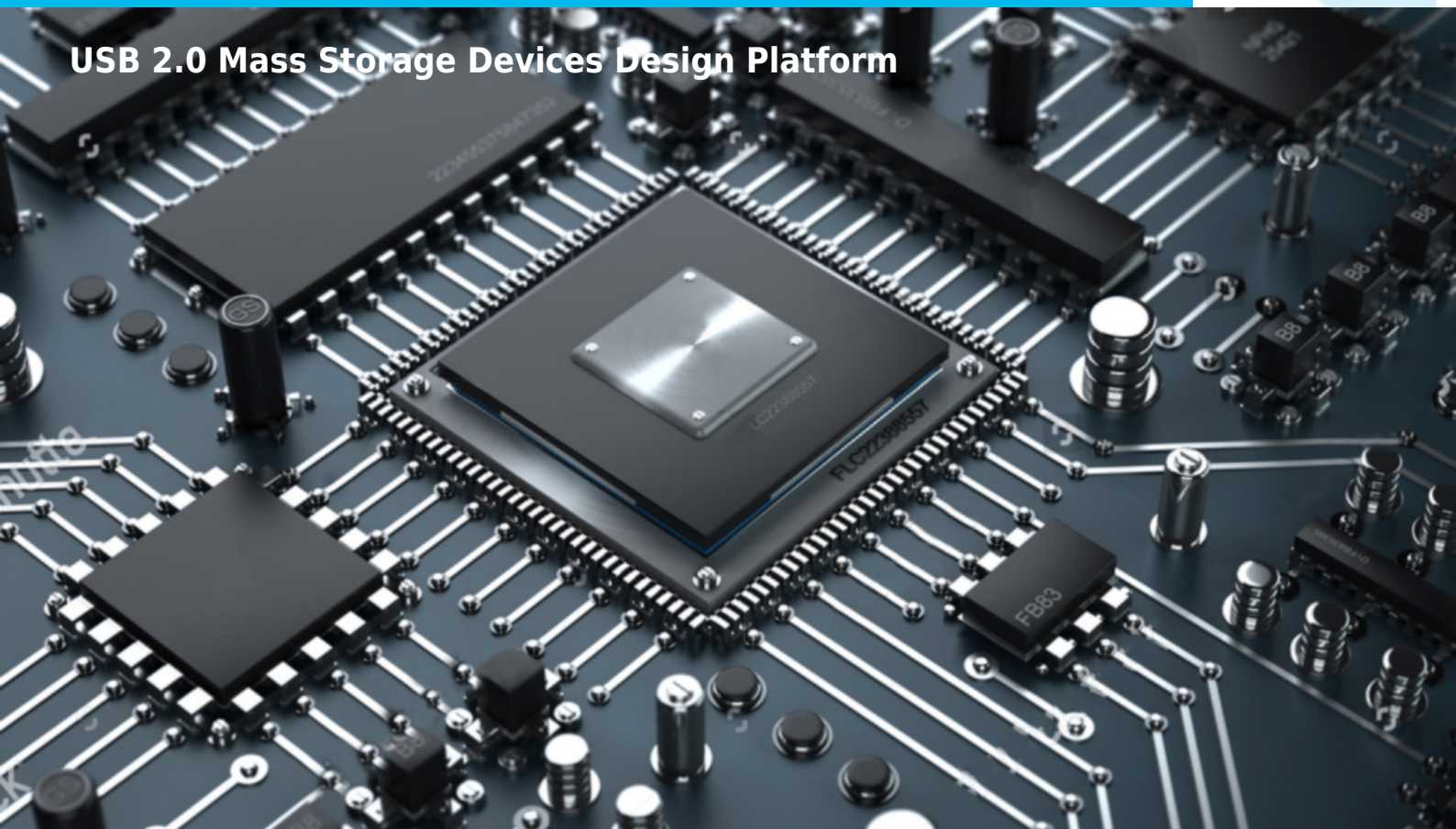


MS PLATFORM

USB 2.0 Mass Storage Devices Design Platform



COMPANY OVERVIEW

Digital Core Design is a leading IP Core provider and a System-on-Chip design house. The company was founded in 1999 and since the very beginning has been focused on IP Core architecture improvements. Our innovative, silicon proven solutions have been employed by over 300 customers and with more than 500 hundred licenses sold to companies like Intel, Siemens, Philips, General Electric, Sony and Toyota. Based on more than 70 different architectures, starting from serial interfaces to advanced microcontrollers and SoCs, we are designing solutions tailored to your needs.

IP CORE OVERVIEW

The USB 2.0 **Mass Storage Design Platform** is a complete, integrated solution, dedicated to a wide range of USB-based Mass Storage Devices. You can use it in various applications, like portable flash memory, digital audio player, card reader or digital camera. The complete MS Design Platform includes:

- DUSB2 peripheral controller designed to support 12 Mb/s “Full Speed” (FS) and 480 Mb/s “High Speed” (HS) serial data transmission rates
- DP8051XP ultra high performance, speed optimized, fully customizable 8051 8-bit microcontrollers with built-in DoCD™ debug IP core
- Mass Storage Devices software stack optimized for DP8051XP 8-bit CPU
- FPGA board with ready-to-use, preprogrammed example flash memory device application
- HAD2 - DoCD™ Hardware Assisted Debugger board
- DoCD™ Debug Software
- DoCD™ driver for Keil development software
- DoCD™ driver for IAR development software

DESIGN FEATURES:

ALL DCD'S IP CORES ARE TECHNOLOGY INDEPENDENT WHICH MEANS THAT THEY ARE 100% COMPATIBLE WITH ALL FPGA & ASIC VENDORS E.G.

- **Altera / Intel,**
- **Xilinx / AMD,**
- **Lattice,**
- **Microsemi / Microchip,**
and others.
- **TSMC**
- **UMC**
- **SK Hynix**
and others.

KEY FEATURES

- Full compliance with the USB 2.0 specification
- Full-speed 12 Mbps operation
- High-speed 480 Mbps operation
- Supports UTMI Transceiver Macrocell Interface
- Synchronous RAM interface for FIFOs

- Suspend and resume power management functions
- 100% software compatible with industry standard 8051
- Up to 256 bytes of internal (on-chip) Data Memory
- Up to 64K bytes of internal (on-chip) or external (off-chip) Program Memory
- Up to 16M bytes of external (off-chip) Data Memory
- User programmable Program Memory Wait States solution for wide range of memories speed
- User programmable External Data Memory Wait States solution for wide range of memories speed
- Allows operation from a wide range of CPU clock frequencies
- Fully synthesizable
- Static synchronous design
- Positive edge clocking
- No internal tri-states
- Lite design, small gate count and fast operation
- Scan test ready

APPLICATIONS

- Portable flash memory device
- Digital audio player
- Card reader
- Digital camera

UNITS SUMMARY

UTMI Interface - Clocked by utmclk clock, manages communication with USB 2.0 Transceiver Macrocell. It is responsible for reset detection, speed handshake, token, data and handshake packet reception and transmission.

CPU Interface - Clocked by cpublk clock, manages communication with DP8051XP CPU. DUSB2 core configuration and status registers are located in this module.

SRAM Interface - Manages communication with Synchronous Random Access Memory. It generates address, read and write signals for the SRAM memory and buffers data bytes during the FIFO read and write operations.

EP0 endpoint - A special bidirectional endpoint used for device configuration. Allows generic USB control and status access.

EP1 & EP2 endpoints - Unidirectional configurable endpoints used for application specific data transmission.

DP8051XP CPU - Ultra high performance, speed optimized 8-bit embedded controller, 100% software compatible with industry standard 8051.

DELIVERABLES

- **Source code:**
 - VERILOG or VHDL Source Code
 - VERILOG or VHDL test bench environment
 - Active-HDL automatic simulation macros
 - ModelSim automatic simulation macros
 - Tests with reference responses
- Technical documentation
 - Installation notes
 - HDL core specification
 - Datasheet

- Synthesis scripts
- Example application
- **Netlist**
 - Netlist for selected FPGA family
 - Sample FPGA project
 - Technical documentation
 - HDL core specification
 - Datasheet
- **Technical support**
 - IP Core implementation
 - 3 months maintenance
 - Delivery of the IP Core and documentation updates
 - Phone & email support
 - Design consulting

PERFORMANCE

The following tables give a survey about the Core area and performance in **ASIC** Devices.

Device	Optimization	cpuclk F _{max}	utmickl F _{max}
0.25u typical	area	> 200 MHz	>100 MHz
0.25u typical	speed	> 200 MHz	>100 MHz
0.18u typical	area	> 200 MHz	>100 MHz
0.18u typical	speed	> 200 MHz	>100 MHz
0.13u typical	area	> 200 MHz	>100 MHz
0.13u typical	speed	> 200 MHz	>100 MHz

The area utilized by complete, integrated USB 2.0 HID Design Platform in vendor specific technologies, is summarized in the following table.

Component	Area [Gates]
CPU interface	1 400
UTMI interface	1 600
SRAM interface	700
EPO endpoint	900

EP1 endpoint	1 100
EP2 endpoint	1 100
DP8051XP CPU	7 700
DoCD™ debug IP core	2 200
Total area	16 700

LICENSING

Comprehensible and clearly defined licensing methods without royalty-per-chip fees make use of our IP Cores easy and simple.

- **Single-Site license option** - dedicated to small and middle sized companies which run their business at one place.

- **Multi-Site license option** - dedicated to corporate customers which operate at several locations. The licensed product can be used at selected company branches.

In all cases the number of IP Core instantiations within a project and the number of manufactured chips are unlimited. There are no restrictions regarding the time of use.

There are two formats of the delivered IP Core that you can choose from:

- VHDL or Verilog RTL synthesizable source code (called HDL Source code)

- FPGA EDIF/NGO/NGD/QXP/VQM (called Netlist)

HDL Source code is suitable for ASIC and FPGA projects. The Netlist license is intended for FPGA projects only.

CONTACT

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